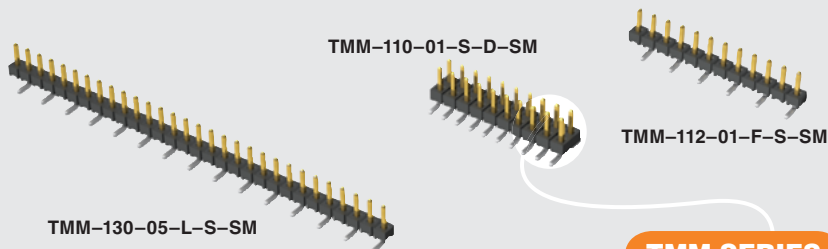




(2,00 mm) .0787"



TMM SERIES

LOW PROFILE SMT HEADER

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?TMM

Insulator Material: Black Liquid Crystal Polymer

Terminal Material: Phosphor Bronze

Plating: Sn or Au over 50µ" (1,27 µm) Ni

Current Rating: 3.2 A per pin (1 pin powered per row)

Operating Temp Range: -55°C to +105°C with Tin; -55°C to +125°C with Gold

Voltage Rating: 500 VAC mated with SQW 450 VAC mated with SQT

RoHS Compliant: Yes

Processing: Lead-Free Solderable: Yes

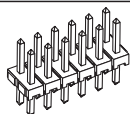
SMT Lead Coplanarity: (0,15 mm) .006" max

Mates with:

CLT, SQT, SQW, ESQT, TLE, SMM, MMS, TCSD

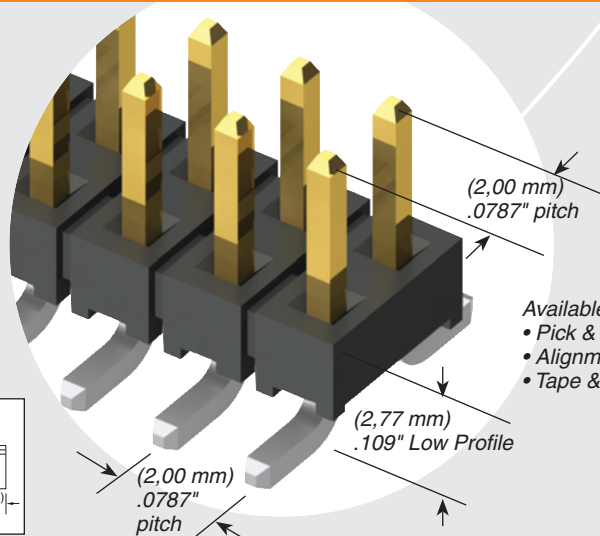
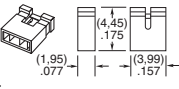
OTHER SOLUTIONS

Through-Hole



2 mm Shunt

Specify **2SN-BK-G** for 2 mm shunt with Gold plating.



Available with optional

- Pick & Place Pads
- Alignment pins
- Tape & reel packaging

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



ALSO AVAILABLE (MOQ Required)

- Other platings
- Contact Samtec.

TMM — **1** **NO. PINS PER ROW** — **LEAD STYLE** — **PLATING OPTION** — **ROW OPTION** — **SM** — **OTHER OPTION**

02 thru 40

Specify **LEAD STYLE** from chart below.

-F
= Gold flash on post, Matte Tin on tail

-L
= 10µ" (0,25 µm) Gold on post, Matte Tin on tail

-S
= 30µ" (0,76 µm) Gold on post, Matte Tin on tail

-T
= Matte Tin

-S
= Single Row

-D
= Double Row

-A
= Alignment Pin (Metal or plastic at Samtec's discretion) (5 positions minimum) (-D only)

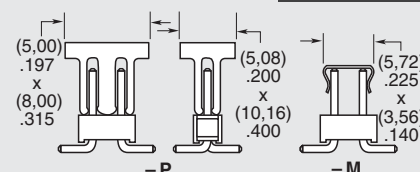
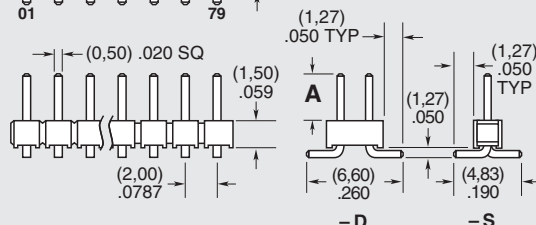
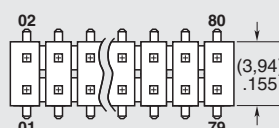
-“XXX”
= Polarized Position (Specify position of omitted pin)

-M
= Metal Pick & Place Pad (4 positions minimum) (-T plating not available) (-D only)

-P
= Pick & Place Pad (3 positions minimum)

-TR
= Tape & Reel Packaging (3 thru 36 positions only)

LEAD STYLE	A	MATES WITH
-01	(3,20) .126	SQT, SQW, ESQT, TLE, SMM, MMS, TCSD
-04	(1,91) .075	CLT
-05	(1,65) .065	CLT
-06	(4,27) .168	CLT-BE



Note: Some lengths, styles and options are non-standard, non-returnable.